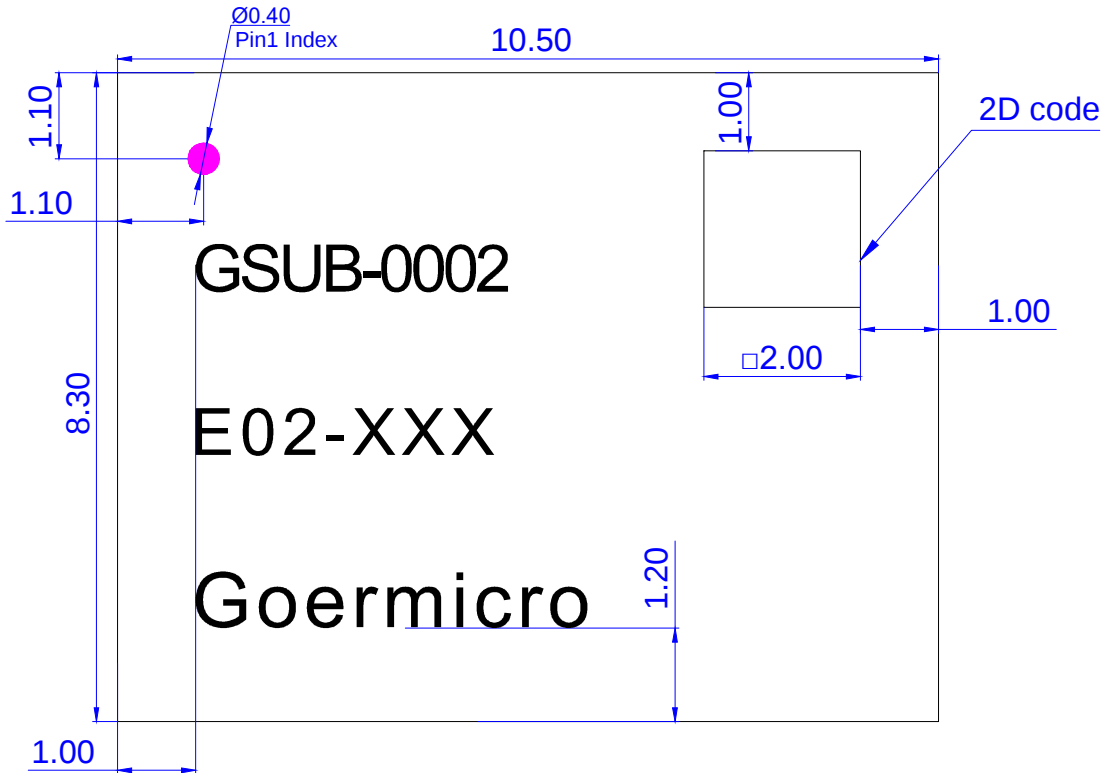




Top View (Chip Side View)

Marking	Content	Height	Font	Type
Logo	Goermicro	0.7	Arial	Laser
Projcet Name	GSUB-0002	0.6		
Version	<i>E02</i>	0.6		
Config Name	<i>XXX</i>	0.6		

2D 码详细信息:**G+1+YWW+D+S+SSS+EEEE+X+SSSS+CCRR**

以（ **G+1+2044+K+001+UB02+2+00FB+010A** ）为例

G:Goermicro

1:Production Line

2044: Date Code-- YWW+D

K:Substrate Vendor Code

001: 001~ZZZ(exculde I&O) , strip count in one day. Reset to 001 at the start of a new day

UB02:Production Name

2:Build Phase No.

00FB:Substrate Lot No

010A:Column(01~20)+Row(0A~0K,exculde I&O)

Confidential		DRAWING NAME		MARKING SPECIFICATION DRAWING	
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILIMETERS TOLERANCES ARE: X. XXX ±0.025 ANGLES ±1° X. XX ±0.05 X. X ±0.10		TITLE		PKG SIZE:10.50MMX8.30MM	
		PROJECT NAME		UNIT	VERSION
		DRAWING NO.		mm	E02
		Goermicro		SHEET 2 / 2	